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Applications of **Embedded - Microprocessors**

Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

Details

Product Status	Obsolete
Core Processor	EC000
Number of Cores/Bus Width	1 Core, 32-Bit
Speed	10MHz
Co-Processors/DSP	-
RAM Controllers	-
Graphics Acceleration	No
Display & Interface Controllers	-
Ethernet	-
SATA	-
USB	-
Voltage - I/O	5.0V
Operating Temperature	0°C ~ 70°C (TA)
Security Features	-
Package / Case	68-LCC (J-Lead)
Supplier Device Package	68-PLCC (24.21x24.21)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mc68hc000ei10r

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1.4 MC68HC000

The primary benefit of the MC68HC000 is reduced power consumption. The device dissipates an order of magnitude less power than the HMOS MC68000.

The MC68HC000 is an implementation of the M68000 16/-32 bit microprocessor architecture. The MC68HC000 has a 16-bit data bus implementation of the MC68000 and is upward code-compatible with the MC68010 virtual extensions and the MC68020 32-bit implementation of the architecture.

1.5 MC68HC001

The MC68HC001 provides a functional extension to the MC68HC000 HCMOS 16-/32-bit microprocessor with the addition of statically selectable 8- or 16-bit data bus operation. The MC68HC001 is object-code compatible with the MC68HC000, and code written for the MC68HC001 can be migrated without modification to any member of the M68000 Family.

1.6 MC68EC000

The MC68EC000 is an economical high-performance embedded controller designed to suit the needs of the cost-sensitive embedded controller market. The HCMOS MC68EC000 has an internal 32-bit architecture that is supported by a statically selectable 8- or 16-bit data bus. This architecture provides a fast and efficient processing device that can satisfy the requirements of sophisticated applications based on high-level languages.

The MC68EC000 is object-code compatible with the MC68000, and code written for the MC68EC000 can be migrated without modification to any member of the M68000 Family.

The MC68EC000 brings the performance level of the M68000 Family to cost levels previously associated with 8-bit microprocessors. The MC68EC000 benefits from the rich M68000 instruction set and its related high code density with low memory bandwidth requirements.



Address Bus (A23–A0)

This 24-bit, unidirectional, three-state bus is capable of addressing 16 Mbytes of data. This bus provides the address for bus operation during all cycles except interrupt acknowledge cycles and breakpoint cycles. During interrupt acknowledge cycles, address lines A1, A2, and A3 provide the level number of the interrupt being acknowledged, and address lines A23–A4 and A0 are driven to logic high. In 16-Bit mode, A0 is always driven high.

MC68008 Address Bus

The unidirectional, three-state buses in the two versions of the **MC68008** differ from each other and from the other processor bus only in the number of address lines and the addressing range. The 20-bit address (A19–A0) of the 48-pin version provides a 1-Mbyte address space; the 52-pin version supports a 22-bit address (A21–A0), extending the address space to 4 Mbytes. During an interrupt acknowledge cycle, the interrupt level number is placed on lines A1, A2, and A3. Lines A0 and A4 through the most significant address line are driven to logic high.

3.2 DATA BUS (D15–D0; MC68008: D7–D0)

This bidirectional, three-state bus is the general-purpose data path. It is 16 bits wide in the all the processors except the **MC68008** which is 8 bits wide. The bus can transfer and accept data of either word or byte length. During an interrupt acknowledge cycle, the external device supplies the vector number on data lines D7–D0. The MC68EC000 and MC68HC001 use D7–D0 in 8-bit mode, and D15–D8 are undefined.

3.3 ASYNCHRONOUS BUS CONTROL

Asynchronous data transfers are controlled by the following signals: address strobe, read/write, upper and lower data strobes, and data transfer acknowledge. These signals are described in the following paragraphs.

Address Strobe (AS).

This three-state signal indicates that the information on the address bus is a valid address.

Read/Write (R/\overline{W}).

This three-state signal defines the data bus transfer as a read or write cycle. The R/\overline{W} signal relates to the data strobe signals described in the following paragraphs.

Upper And Lower Data Strobes (UDS, LDS).

These three-state signals and R/W control the flow of data on the data bus. Table 3-1 lists the combinations of these signals and the corresponding data on the bus. When the R/W line is high, the processor reads from the data bus. When the R/W line is low, the processor drives the data bus. In 8-bit mode, \overline{UDS} is always forced high and the LDS signal is used.



3.6 SYSTEM CONTROL

The system control inputs are used to reset the processor, to halt the processor, and to signal a bus error to the processor. The outputs reset the external devices in the system and signal a processor error halt to those devices. The three system control signals are described in the following paragraphs.

Bus Error (BERR)

This input signal indicates a problem in the current bus cycle. The problem may be the following:

- 1. No response from a device.
- 2. No interrupt vector number returned.
- 3. An illegal access request rejected by a memory management unit.
- 4. Some other application-dependent error.

Either the processor retries the bus cycle or performs exception processing, as determined by interaction between the bus error signal and the halt signal.

Reset (RESET)

The external assertion of this bidirectional signal along with the assertion of \overline{HALT} starts a system initialization sequence by resetting the processor. The processor assertion of RESET (from executing a RESET instruction) resets all external devices of a system without affecting the internal state of the processor. To reset both the processor and the external devices, the RESET and HALT input signals must be asserted at the same time.

Halt (HALT)

An input to this bidirectional signal causes the processor to stop bus activity at the completion of the current bus cycle. This operation places all control signals in the inactive state and places all three-state lines in the high-impedance state (refer to Table 3-4).

When the processor has stopped executing instructions (in the case of a double bus fault condition, for example), the \overline{HALT} line is driven by the processor to indicate the condition to external devices.

Mode (MODE) (MC68HC001/68EC000)

The MODE input selects between the 8-bit and 16-bit operating modes. If this input is grounded at reset, the processor will come out of reset in the 8-bit mode. If this input is tied high or floating at reset, the processor will come out of reset in the 16-bit mode. This input should be changed only at reset and must be stable two clocks after RESET is negated. Changing this input during normal operation may produce unpredictable results.



The descriptions of the eight states of a write cycle are as follows:

- STATE 0 The write cycle starts in S0. The processor places valid function codes on FC2-FC0 and drives R/W high (if a preceding write cycle has left R/W low).
- STATE 1 Entering S1, the processor drives a valid address on the address bus.
- STATE 2 On the rising edge of S2, the processor asserts \overline{AS} and drives R/\overline{W} low.
- STATE 3 During S3, the data bus is driven out of the high-impedance state as the data to be written is placed on the bus.
- STATE 4 At the rising edge of S4, the processor asserts \overline{LDS} , or \overline{DS} . The processor waits for a cycle termination signal (\overline{DTACK} or \overline{BERR}) or \overline{VPA} , an M6800 peripheral signal. When \overline{VPA} is asserted during S4, the cycle becomes a peripheral cycle (refer to **Appendix B M6800 Peripheral Interface**). If neither termination signal is asserted before the falling edge at the end of S4, the processor inserts wait states (full clock cycles) until either \overline{DTACK} or \overline{BERR} is asserted.
- STATE 5 During S5, no bus signals are altered.
- STATE 6 During S6, no bus signals are altered.
- STATE 7 On the falling edge of the clock entering S7, the processor negates \overline{AS} , \overline{LDS} , and \overline{DS} . As the clock rises at the end of S7, the processor places the address and data buses in the high-impedance state, and drives R/W high. The device negates \overline{DTACK} or \overline{BERR} at this time.

4.1.3 Read-Modify-Write Cycle.

The read-modify-write cycle performs a read operation, modifies the data in the arithmetic logic unit, and writes the data back to the same address. The address strobe (\overline{AS}) remains asserted throughout the entire cycle, making the cycle indivisible. The test and set (TAS) instruction uses this cycle to provide a signaling capability without deadlock between processors in a multiprocessing environment. The TAS instruction (the only instruction that uses the read-modify-write cycle) only operates on bytes. Thus, all read-modify-write cycle operations. Figure 4-5 and 4-6 illustrate the read-modify-write cycle operation.





Figure 4-5. Read-Modify-Write Cycle Flowchart



bus request signal. When no acknowledge is received before the bus request signal is negated, the processor continues the use of the bus.

5.2.2 Receiving The Bus Grant

The processor asserts \overline{BG} as soon as possible. Normally, this process immediately follows internal synchronization, except when the processor has made an internal decision to execute the next bus cycle but has not yet asserted \overline{AS} for that cycle. In this case, \overline{BG} is delayed until \overline{AS} is asserted to indicate to external devices that a bus cycle is in progress.

BG can be routed through a daisy-chained network or through a specific priority-encoded network. Any method of external arbitration that observes the protocol can be used.

5.2.3 Acknowledgment Of Mastership (3-Wire Bus Arbitration Only)

Upon receiving BG, the requesting device waits until AS, DTACK, and BGACK are negated before asserting BGACK. The negation of AS indicates that the previous bus master has completed its cycle. (No device is allowed to assume bus mastership while AS is asserted.) The negation of BGACK indicates that the previous master has released the bus. The negation of DTACK indicates that the previous slave has terminated the connection to the previous master. (In some applications, DTACK might not be included in this function; general-purpose devices would be connected using AS only.) When BGACK is asserted, the asserting device is bus master until it negates BGACK. BGACK should not be negated until after the bus cycle(s) is complete. A device relinquishes control of the bus by negating BGACK.

The bus request from the granted device should be negated after \overline{BGACK} is asserted. If another bus request is pending, \overline{BG} is reasserted within a few clocks, as described in **5.3 Bus Arbitration Control**. The processor does not perform any external bus cycles before reasserting \overline{BG} .

5.3 BUS ARBITRATION CONTROL

All asynchronous bus arbitration signals to the processor are synchronized before being used internally. As shown in Figure 5-17, synchronization requires a maximum of one cycle of the system clock, assuming that the asynchronous input setup time (#47, defined in **Section 10 Electrical Characteristic**) has been met. The input asynchronous signal is sampled on the falling edge of the clock and is valid internally after the next falling edge.



A double bus fault occurs during a reset operation when a bus error occurs while the processor is reading the vector table (before the first instruction is executed). The reset operation is described in the following paragraph.

5.5 RESET OPERATION

RESET is asserted externally for the initial processor reset. Subsequently, the signal can be asserted either externally or internally (executing a RESET instruction). For proper external reset operation, HALT must also be asserted.

When RESET and HALT are driven by an external device, the entire system, including the processor, is reset. Resetting the processor initializes the internal state. The processor reads the reset vector table entry (address \$00000) and loads the contents into the supervisor stack pointer (SSP). Next, the processor loads the contents of address \$00004 (vector table entry 1) into the program counter. Then the processor initializes the interrupt level in the status register to a value of seven. In the MC68010, the processor also clears the vector base register to \$00000. No other register is affected by the reset sequence. Figure 5-30 shows the timing of the reset operation.



Figure 5-30. Reset Operation Timing Diagram

The RESET instruction causes the processor to assert $\overrightarrow{\text{RESET}}$ for 124 clock periods to reset the external devices of the system. The internal state of the processor is not affected. Neither the status register nor any of the internal registers is affected by an internal reset operation. All external devices in the system should be reset at the completion of the RESET instruction.

For the initial reset, RESET and HALT must be asserted for at least 100 ms. For a subsequent external reset, asserting these signals for 10 clock cycles or longer resets the processor. However, an external reset signal that is asserted while the processor is



On the rising edge of the clock, at the end of S7 (which may be the start of S0 for the next bus cycle), the processor places the address bus in the high-impedance state. During a write cycle, the processor also places the data bus in the high-impedance state and drives R/W high. External logic circuitry should respond to the negation of the \overline{AS} and \overline{UDS} , \overline{LDS} , and/or \overline{DS} by negating \overline{DTACK} and/or \overline{BERR} . Parameter #28 is the hold time for \overline{DTACK} , and parameter #30 is the hold time for \overline{BERR} .

Figure 5-35 shows a synchronous read cycle and the important timing parameters that apply. The timing for a synchronous read cycle, including relevant timing parameters, is shown in Figure 5-36.



Figure 5-35. Synchronous Read Cycle





Figure 5-36. Synchronous Write Cycle

A key consideration when designing in a synchronous environment is the timing for the assertion of DTACK and BERR by an external device. To properly use external inputs, the processor must synchronize these signals to the internal clock. The processor must sample the external signal, which has no defined phase relationship to the CPU clock, which may be changing at sampling time, and must determine whether to consider the signal high or low during the succeeding clock period. Successful synchronization requires that the internal machine receives a valid logic level (not a metastable signal), whether the input is high, low, or in transition. Metastable signals propagating through synchronous machines can produce unpredictable operation.

Figure 5-37 is a conceptual representation of the input synchronizers used by the M68000 Family processors. The input latches allow the input to propagate through to the output when E is high. When low, E latches the input. The three latches require one cycle of CLK to synchronize an external signal. The high-gain characteristics of the devices comprising the latches quickly resolve a marginal signal into a valid state.



Figure 5-37. Input Synchronizers

Format Code	Stacked Information
0000	Short Format (4 Words)
1000	Long Format (29 Words)
All Others	Unassigned, Reserved

Table 6-4. MC68010 Format Codes

6.2.5 Exception Processing Sequence

In the first step of exception processing, an internal copy is made of the status register. After the copy is made, the S bit of the status register is set, putting the processor into the supervisor mode. Also, the T bit is cleared, which allows the exception handler to execute unhindered by tracing. For the reset and interrupt exceptions, the interrupt priority mask is also updated appropriately.

In the second step, the vector number of the exception is determined. For interrupts, the vector number is obtained by a processor bus cycle classified as an interrupt acknowledge cycle. For all other exceptions, internal logic provides the vector number. This vector number is then used to calculate the address of the exception vector.

The third step, except for the reset exception, is to save the current processor status. (The reset exception does not save the context and skips this step.) The current program counter value and the saved copy of the status register are stacked using the SSP. The stacked program counter value usually points to the next unexecuted instruction. However, for bus error and address error, the value stacked for the program counter is unpredictable and may be incremented from the address of the instruction that caused the error. Group 1 and 2 exceptions use a short format exception stack frame (format = 0000 on the MC68010). Additional information defining the current context is stacked for the bus error and address error exceptions.

The last step is the same for all exceptions. The new program counter value is fetched from the exception vector. The processor then resumes instruction execution. The instruction at the address in the exception vector is fetched, and normal instruction decoding and execution is started.

6.3 PROCESSING OF SPECIFIC EXCEPTIONS

The exceptions are classified according to their sources, and each type is processed differently. The following paragraphs describe in detail the types of exceptions and the processing of each type.

6.3.1 Reset

The reset exception corresponds to the highest exception level. The processing of the reset exception is performed for system initiation and recovery from catastrophic failure. Any processing in progress at the time of the reset is aborted and cannot be recovered. The processor is forced into the supervisor state, and the trace state is forced off. The

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7.7 BIT MANIPULATION INSTRUCTION EXECUTION TIMES

Table 7-9 lists the timing data for the bit manipulation instructions. The total number of clock periods, the number of read cycles, and the number of write cycles are shown in the previously described format. The number of clock periods, the number of read cycles, and the number of write cycles, respectively, must be added to those of the effective address calculation where indicated by a plus sign (+).

		Dynamic Stat			itic	
Instruction	Size	Register	Memory	Register	Memory	
BCHG	Byte Long	12 (2/0)*	12 (2/1)+	20 (4/0)*	20 (4/1)+	
BCLR	Byte Long	14 (2/0)*	12 (2/1)+	22 (4/0)*	20 (4/1)+	
BSET	Byte Long	12 (2/0)*	12 (2/1)+	20 (4/0)*	20 (4/1)+	
BTST	Byte Long	10 (2/0)	8(2/0)+	18 (4/0)	16 (4/0)+	

Table 7-9. Bit Manipulation Instruction Execution Times

+Add effective address calculation time.

* Indicates maximum value; data addressing mode only.

7.8 CONDITIONAL INSTRUCTION EXECUTION TIMES

Table 7-10 lists the timing data for the conditional instructions. The total number of clock periods, the number of read cycles, and the number of write cycles are shown in the previously described format. The number of clock periods, the number of read cycles, and the number of write cycles, respectively, must be added to those of the effective address calculation where indicated by a plus sign (+).

Instruction	Displacement	Trap or Branch Taken	Trap or Branch Not Taken
Bcc	Byte Word	18 (4/0) 18 (4/0)	12 (2/0) 20 (4/0)
BRA	Byte Word	18 (4/0) 18 (4/0)	_
BSR	Byte Word	34 (4/4) 34 (4/4)	_
DBcc	CC True CC False	18 (4/0)	20 (4/0) 26 (6/0)
СНК	_	68 (8/6)+*	14(2/0)
TRAP	_	62 (8/6)	_
TRAPV	—	66 (10/6)	8 (2/0)

 Table 7-10. Conditional Instruction Execution Times

+Add effective address calculation time for word operand.

* Indicates maximum base value.



		Destination							
Source	Dn	An	(An)	(An)+	–(An)	(d ₁₆ , An)	(dგ, An, Xn)*	(xxx).W	(xxx).L
Dn	4 (1/0)	4 (1/0)	12 (1/2)	12 (1/2)	12 (1/2)	16 (2/2)	18(2/2)	16 (2/2)	20 (3/2)
An	4 (1/0)	4 (1/0)	12 (1/2)	12 (1/2)	12 (1/2)	16 (2/2)	18(2/2)	16 (2/2)	20 (3/2)
(An)	12 (3/0)	12 (3/0)	20 (3/2)	20 (3/2)	20 (3/2)	24 (4/2)	26(4/2)	24 (4/2)	28 (5/2)
(An)+	12 (3/0)	12 (3/0)	20 (3/2)	20 (3/2)	20 (3/2)	24 (4/2)	26 (4/2)	24 (4/2)	28 (5/2)
–(An)	14 (3/0)	14 (3/0)	22 (3/2)	22 (3/2)	22 (3/2)	26 (4/2)	28 (4/2)	26 (4/2)	30 (5/2)
(d ₁₆ , An)	16 (4/0)	16 (4/0)	24 (4/2)	24 (4/2)	24 (4/2)	28 (5/2)	30 (5/2)	28 (5/2)	32 (6/2)
(d g, An, Xn)*	18 (4/0)	18 (4/0)	26 (4/2)	26 (4/2)	26 (4/2)	30 (5/2)	32 (5/2)	30 (5/2)	34 (6/2)
(xxx).W	16 (4/0)	16 (4/0)	24 (4/2)	24 (4/2)	24 (4/2)	28 (5/2)	30 (5/2)	28 (5/2)	32 (6/2)
(xxx).L	20 (5/0)	20 (5/0)	28 (5/2)	28 (5/2)	28 (5/2)	32 (6/2)	34 (6/2)	32 (6/2)	36 (7/2)
(d, PC)	16 (4/0)	16 (4/0)	24 (4/2)	24 (4/2)	24 (4/2)	28 (5/2)	30 (5/2)	28 (5/2)	32 (5/2)
(d, PC, Xn)*	18 (4/0)	18 (4/0)	26 (4/2)	26 (4/2)	26 (4/2)	30 (5/2)	32 (5/2)	30 (5/2)	34 (6/2)
# <data></data>	12 (3/0)	12 (3/0)	20 (3/2)	20 (3/2)	20 (3/2)	24 (4/2)	26 (4/2)	24 (4/2)	28 (5/2)

Table 8-3. Move Long Instruction Execution Times

*The size of the index register (Xn) does not affect execution time.

8.3 STANDARD INSTRUCTION EXECUTION TIMES

The numbers of clock periods shown in Table 8-4 indicate the times required to perform the operations, store the results, and read the next instruction. The total number of clock periods, the number of read cycles, and the number of write cycles are shown in the previously described format. The number of clock periods, the number of read cycles, and the number of write cycles, respectively, must be added to those of the effective address calculation where indicated by a plus sign (+).

In Table 8-4, the following notation applies:

- An Address register operand
- Dn Data register operand
- ea An operand specified by an effective address
- M Memory effective address operand



		Lo	op Continue	ed	Loop Terminated					
	_	Valid	Count, cc F	alse	Valid Count, cc True			Expired Count		
Instruction	Size	(An)	(An)+	–(An)	(An)	(An)+	–(An)	(An)	(An)+	–(An)
CLR	Byte, Word	10 (0/1)	10 (0/1)	12 (0/1)	18 (2/1)	18 (2/1)	20 (2/0)	16 (2/1)	16 (2/1)	18 (2/1)
	Long	14 (0/2)	14 (0/2)	16 (0/2)	22 (2/2)	22 (2/2)	24 (2/2)	20 (2/2)	20 (2/2)	22 (2/2)
NBCD	Byte	18 (1/1)	18 (1/1)	20 (1/1)	24 (3/1)	24 (3/1)	26 (3/1)	22 (3/1)	22 (3/1)	24 (3/1)
NEG	Byte, Word	16 (1/1)	16 (1/1)	18 (2/2)	22 (3/1)	22 (3/1)	24 (3/1)	20 (3/1)	20 (3/1)	22 (3/1)
	Long	24 (2/2)	24 (2/2)	26 (2/2)	30 (4/2)	30 (4/2)	32 (4/2)	28 (4/2)	28 (4/2)	30 (4/2)
NEGX	Byte, Word	16 (1/1)	16 (1/1)	18 (2/2)	22 (3/1)	22 (3/1)	24 (3/1)	20 (3/1)	20 (3/1)	22 (3/1)
	Long	24 (2/2)	24 (2/2)	26 (2/2)	30 (4/2)	30 (4/2)	32 (4/2)	28 (4/2)	28 (4/2)	30 (4/2)
NOT	Byte, Word	16 (1/1)	16 (1/1)	18 (2/2)	22 (3/1)	22 (3/1)	24 (3/1)	20 (3/1)	20 (3/1)	22 (3/1)
	Long	24 (2/2)	24 (2/2)	26 (2/2)	30 (4/2)	30 (4/2)	32 (4/2)	28 (4/2)	28 (4/2)	30 (4/2)
TST	Byte, Word	12 (1/0)	12 (1/0)	14 (1/0)	18 (3/0)	18 (3/0)	20 (3/0)	16 (3/0)	16 (3/0)	18 (3/0)
	Long	18 (2/0)	18 (2/0)	20 (2/0)	24 (4/0)	24 (4/0)	26 (4/0)	20 (4/0)	20 (4/0)	22 (4/0)

 Table 9-11. Single Operand Instruction Loop Mode Execution Times

9.6 SHIFT/ROTATE INSTRUCTION EXECUTION TIMES

Tables 9-12 and 9-13 list the timing data for the shift and rotate instructions. The total number of clock periods, the number of read cycles, and the number of write cycles are shown in the previously described format. The number of clock periods, the number of read cycles, and the number of write cycles, respectively, must be added to those of the effective address calculation where indicated by a plus sign (+).

Instruction	Size	Register	Memory*
ASR, ASL	Byte, Word	6+2n (1/0)	8 (1/1)+
	Long	8+2n (1/0)	—
LSR, LSL	Byte, Word 6+2n (1/0)		8 (1/1)+
	Long	8+2n (1/0)	—
ROR, ROL	Byte, Word	6+2n (1/0)	8 (1/1)+
	Long	8+2n (1/0)	—
ROXR, ROXL	Byte, Word	6+2n (1/0)	8 (1/1)+
	Long	8+2n (1/0)	_

Table 9-12. S	Shift/Rotate	Instruction	Execution	Times
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+Add effective address calculation time.

n is the shift or rotate count.

* Word only.

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9.12 EXCEPTION PROCESSING EXECUTION TIMES

Table 9-19 lists the timing data for exception processing. The numbers of clock periods include the times for all stacking, the vector fetch, and the fetch of the first instruction of the handler routine. The total number of clock periods, the number of read cycles, and the number of write cycles are shown in the previously described format. The number of clock periods, the number of read cycles, and the number of write cycles, respectively, must be added to those of the effective address calculation where indicated by a plus sign (+).

Exception	
Address Error	126 (4/26)
Breakpoint Instruction*	45 (5/4)
Bus Error	126 (4/26)
CHK Instruction**	44 (5/4)+
Divide By Zero	42 (5/4)+
Illegal Instruction	38 (5/4)
Interrupt*	46 (5/4)
MOVEC, Illegal Control Register**	46 (5/4)
Privilege Violation	38 (5/4)
Reset***	40 (6/0)
RTE, Illegal Format	50 (7/4)
RTE, Illegal Revision	70 (12/4)
Trace	38(4/4)
TRAP Instruction	38(4/4)
TRAPV Instruction	38 (5/4)

Table 9-19. Exception Processing Execution Times

+ Add effective address calculation time.

* The interrupt acknowledge and breakpoint cycles are assumed to take four clock periods.

** Indicates maximum value.

*** Indicates the time from when RESET and HALT are first sampled as negated to when instruction execution starts.



10.13 MC68EC000 DC ELECTRICAL SPECIFICATIONS (VCC=5.0 VDC \pm 5;PC; GND=0 VDC; T_A = T_L TO T_H)

Characteristic	Symbol	Min	Max	Unit
Input High Voltage	VIH	2.0	V _{CC}	V
Input Low Voltage	VIL	GND-0.3	0.8	V
Input Leakage CurrentBERR, BR, DTACK, CLK, IPL2-IPL0, AVEC@5.25 VMODE, HALT, RESET	l _{in}		2.5 20	μΑ
Three-State (Off State) Input Current AS, A23–A0, D15–D0, @2.4 V/0.4 V FC2–FC0, LDS, R/W, UDS	ITSI	—	20	μΑ
Output High Voltage AS, A23–A0, BG, D15–D0, (IOH=-400 μA) FC2–FC0, LDS, R/W, UDS	∨он	VCC0.75		V
Output Low Voltage (IOL = 1.6 mA)HALT $(IOL = 3.2 \text{ mA})$ A23-A0, \overline{BG} , FC2-FC0 $(IOL = 5.0 \text{ mA})$ RESET $(IOL = 5.3 \text{ mA})$ \overline{AS} , D15-D0, \overline{LDS} , R/W, \overline{UDS} Current Dissipation*f=8 MHz	VOL		0.5 0.5 0.5 0.5	V
f=10 MHz f=12.5 MHz f=16.67 MHz f=20 MHz			23 30 35 50 70	ША
Power Dissipation f=8 MHz f=10 MHz f=10 MHz f=12.5 MHz f=16.67 MHz f=20 MHz f=20 MHz	PD		0.13 0.16 0.19 0.26 0.38	W
Capacitance (Vin=0 V, TA=25°C, Frequency=1 MHz)**	Cin	_	20.0	pF
Load Capacitance HALT All Others	CL		70 130	pF

*Currents listed are with no loading.

** Capacitance is periodically sampled rather than 100% tested.





NOTES:

1. Timing measurements are referenced to and from a low voltage of 0.8 V and a high voltage of 2.0 V, unless otherwise noted. The voltage swing through this range should start outside and pass through the range such that the rise or fall is linear <u>between 0.8 V and 2.0 V</u>.

2. Because of loading variations, R/W may be valid after AS even though both are initiated by the rising edge of S2 (specification #20A).

Figure 10-13. MC68EC000 Write Cycle Timing Diagram

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Figure 11-5. 48-Pin Dual In Line



Opcodes	Applicable Addressing Modes
MOVE [BWL]	(Ay) to (Ax) (Ay) to (Ax)+ (Ay) to $-(Ax)$ (Ay)+ to (Ax) (Ay)+ to $-(Ax)$ -(Ay) to (Ax) -(Ay) to (Ax)+ -(Ay) to $-(Ax)Ry to (Ax)Ry to (Ax)+$
ADD [BWL] AND [BWL] CMP [BWL] OR [BWL] SUB [BWL]	(Ay) to Dx (Ay)+ to Dx –(Ay) to Dx
ADDA [WL] CMPA [WL] SUBA [WL]	(Ay) to Ax –(Ay) to Ax (Ay)+ to Ax
ADD [BWL] AND [BWL] EOR [BWL] OR [BWL] SUB [BWL]	Dx to (Ay) Dx to (Ay)+ Dx to –(Ay)
ABCD [B] ADDX [BWL] SBCD [B] SUBX [BWL]	–(Ay) to –(Ax)
CMP [BWL]	(Ay)+ to (Ax)+
CLR [BWL] NEG [BWL] NEGX [BWL} NOT [BWL] TST [BWL] NBCD [B]	(Ay) (Ay)+ –(Ay)
ASL [W] ASR [W] LSL [W] LSR [W] ROL [W] ROR [W] ROXL [W] ROXR	(Ay) by #1 (Ay)+ by #1 –(Ay) by #1

Table A-1. MC68010 Loop Mode Instructions

NOTE: [B, W, or L] indicate an operand size of byte, word, or long word.